

STGW30N90D

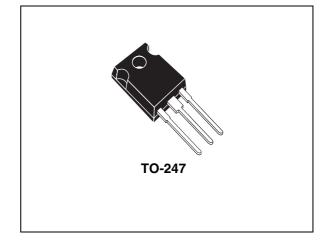
N-channel 900V - 30A - TO-247 Very fast PowerMESH™ IGBT

Preliminary Data

Features

Туре	V _{CES}	V _{CE(sat)} @25°C	I _C @100°C
STGW30N90D	900V	< 2.75V	30A

- Low on-losses
- Low on-voltage drop (V_{cesat})
- High current capability
- High input impedance (voltage driven)
- Low gate charge
- Ideal for soft switching application



Description

Using the latest high voltage technology based on its patented strip layout, STMicroelectronics has designed an advanced family of IGBTs, with outstanding performances.

Application

■ Induction heating

Figure 1. Internal schematic diagram

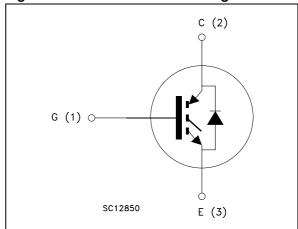


Table 1. Device summary

Order code	Marking	Package	Packaging
STGW30N90D	GW30N90D	TO-247	Tube

Contents STGW30N90D

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STGW30N90D Electrical ratings

1 Electrical ratings

Table 2. Absolute maximum ratings

Symbol	Parameter	Value	Unit
V _{CES}	Collector-emitter voltage (V _{GS} = 0)	900	V
I _C ⁽¹⁾	Collector current (continuous) at 25°C	60	Α
I _C ⁽¹⁾	Collector current (continuous) at 100°C	30	Α
I _{CL} ⁽²⁾	Collector current (pulsed)	135	Α
V _{GE}	Gate-emitter voltage	±25	V
P _{TOT}	Total dissipation at T _C = 25°C	220	W
I _f	Diode RMS forward current at T _C = 25°C	30	Α
T _j	Operating junction temperature		
T _{stg}	Storage temperature	-33 10 130	°C

^{1.} Calculated according to the iterative formula:

$$I_{C}(T_{C}) = \frac{T_{JMAX}^{-T}C}{R_{THJ-C}^{\times V}CESAT(MAX)^{(T}C, \ I_{C})}$$

2. Vclamp=900V, Tj=125°C, R_G =10 Ω , V_{GE} =15V

Table 3. Thermal resistance

Symbol	Parameter	Value	Unit
Rthj-case	Thermal resistance junction-case	0.57	°C/W
Rthj-amb	Thermal resistance junction-ambient (diode)	1.6	°C/W
Rthj-amb	Thermal resistance junction-ambient (IGBT)	50	°C/W

Electrical characteristics STGW30N90D

2 Electrical characteristics

(T_{CASE} =25°C unless otherwise specified)

Table 4. Static electrical characteristics

Symbol	Parameter Test conditions		Min.	Тур.	Max.	Unit
V _{BR(CES)}	Collector-emitter breakdown voltage	$I_C = 1$ mA, $V_{GE} = 0$	900			V
V _{CE(SAT)}	Collector-emitter saturation voltage V _{GE} = 15V, I _C = 20A, Tj= 25°C V _{GE} = 15V, I _C = 20A, Tj=125°C			2.2 2.0	2.75	V V
V _{GE(th)}	Gate threshold voltage	$V_{CE} = V_{GE}, I_{C} = 250 \mu A$	3.75		5.75	V
I _{CES}	Collector-emitter leakage current (V _{CE} = 0)	V _{GE} =Max rating,Tc=25°C V _{GE} =Max rating, Tc=125°C			500 10	μA mA
I _{GES}	Gate-emitter leakage current (V _{CE} = 0)	V _{GE} =± 20V, V _{CE} = 0			± 100	nA
9 _{fs}	Forward transconductance	$V_{CE} = 25V_{,} I_{C} = 20A$		14		S

Table 5. Dynamic electrical characteristics

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Symbol	Parameter	Test conditions	Min.	Тур.	Max.	Unit
C _{ies} C _{oes} C _{res}	Input capacitance Output capacitance Reverse transfer capacitance	V _{CE} = 25V, f = 1 MHz, V _{GE} =0		2510 175 30		pF pF pF
Q _g Q _{ge} Q _{gc}	Total gate charge Gate-emitter charge Gate-collector charge	V _{CE} = 900V, I _C = 20A,V _{GE} =15V		110 16 49	120	nC nC nC

Table 6. Switching on/off (inductive load)

Symbol	Parameter	Test conditions	Min.	Тур.	Max.	Unit
t _{d(on)} t _r (di/dt) _{on}	Turn-on delay time Current rise time Turn-on current slope	V_{CC} = 900V, I_{C} = 20A R_{G} = 10 Ω , V_{GE} = 15V, T_{J} =25°C (see Figure 2)		29 11 1820		ns ns A/µs
t _{d(on)} t _r (di/dt) _{on}	Turn-on delay time Current rise time Turn-on current slope	V_{CC} = 900V, I_{C} = 20A R_{G} = 10 Ω V_{GE} = 15V, T_{J} = 125°C (see Figure 2)		27 14 1580		ns ns A/µs
$t_{\rm r}({ m V}_{ m off}) \ t_{ m d}({ m off}) \ t_{ m f}$	Off voltage rise time Turn-off delay time Current fall time	V_{CC} = 900V, I_{C} = 20A R_{G} = 10 Ω V_{GE} = 15V, T_{J} = 25°C (see Figure 2)		90 275 312		ns ns ns
$t_{r}(V_{off})$ $t_{d}(_{off})$ t_{f}	Off voltage rise time Turn-off delay time Current fall time	V_{CC} = 900V, I_{C} = 20A R_{G} = 10 Ω V_{GE} = 15V, T_{J} = 125°C (see Figure 2)		150 336 592		ns ns ns

Table 7. Switching energy (inductive load)

Symbol	Parameter	Test conditions	Min.	Тур.	Max.	Unit
Eon ⁽¹⁾ E_{off} E_{ts}	Turn-on switching losses Turn-off switching losses Total switching losses	V_{CC} = 900V, I_{C} = 20A R_{G} = 10 Ω V_{GE} = 15V, T_{J} = 25°C (see Figure 2)		1660 4438 6096		μJ μJ μJ
Eon ⁽¹⁾ E_{off} E_{ts}	Turn-on switching losses Turn-off switching losses Total switching losses	V_{CC} = 900V, I_{C} = 20A R_{G} = 10 Ω V_{GE} = 15V, T_{J} = 125°C (see Figure 2)		3015 6900 9915		μJ μJ μJ

Eon is the turn-on losses when a typical diode is used in the test circuit in figure 2. If the IGBT is offered in a package with a co-pack diode, the co-pack diode is used as external diode. IGBTs & Diode are at the same temperature (25°C and 125°C)

Table 8. Collector-emitter diode

Symbol	Parameter	Test conditions	Min.	Тур.	Max.	Unit
V _f	Forward on-voltage	If = 20A, Tj = 25°C If = 20A, Tj = 125°C		1.9 1.7	2.5	V V
t _{rr} Q _{rr} I _{rrm}	Reverse recovery time Reverse recovery charge Reverse recovery current	If = 20A, V_R = 27V, T_j = 125°C, di/dt = 100A/ μ s (see Figure 5)		152 722 9		ns nC A

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^{2.} Turn-off losses include also the tail of the collector current

Test circuit STGW30N90D

3 Test circuit

Figure 2. Test circuit for inductive load switching

Figure 3. Gate charge test circuit

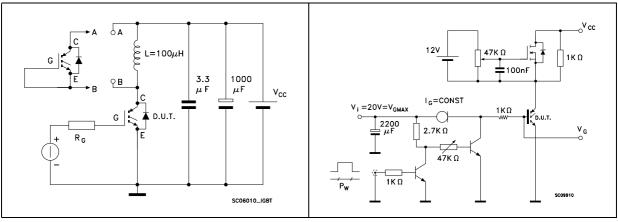
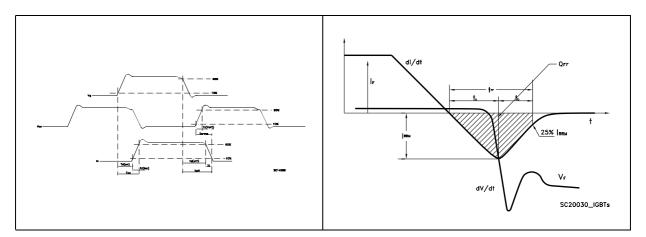


Figure 4. Switching waveform

Figure 5. Diode recovery time waveform



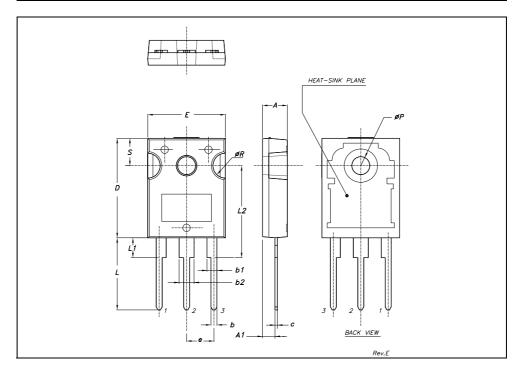
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4 Package mechanical data

In order to meet environmental requirements, ST offers these devices in ECOPACK® packages. These packages have a Lead-free second level interconnect. The category of second level interconnect is marked on the package and on the inner box label, in compliance with JEDEC Standard JESD97. The maximum ratings related to soldering conditions are also marked on the inner box label. ECOPACK is an ST trademark. ECOPACK specifications are available at: www.st.com

TO-247 MECHANICAL DATA

DIM		mm.			inch	
DIM.	MIN.	TYP	MAX.	MIN.	TYP.	MAX.
Α	4.85		5.15	0.19		0.20
A1	2.20		2.60	0.086		0.102
b	1.0		1.40	0.039		0.055
b1	2.0		2.40	0.079		0.094
b2	3.0		3.40	0.118		0.134
С	0.40		0.80	0.015		0.03
D	19.85		20.15	0.781		0.793
Е	15.45		15.75	0.608		0.620
е		5.45			0.214	
L	14.20		14.80	0.560		0.582
L1	3.70		4.30	0.14		0.17
L2		18.50			0.728	
øΡ	3.55		3.65	0.140		0.143
øR	4.50		5.50	0.177		0.216
S		5.50			0.216	



STGW30N90D Revision history

5 Revision history

Table 9. Revision history

Date	Revision	Changes
19-Jul-2006	1	First issue.

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